### 2.0x1.25mm SMD CHIP LED LAMP

Part Number: KPHBM-2012SURKCGKC

Hyper Red Green

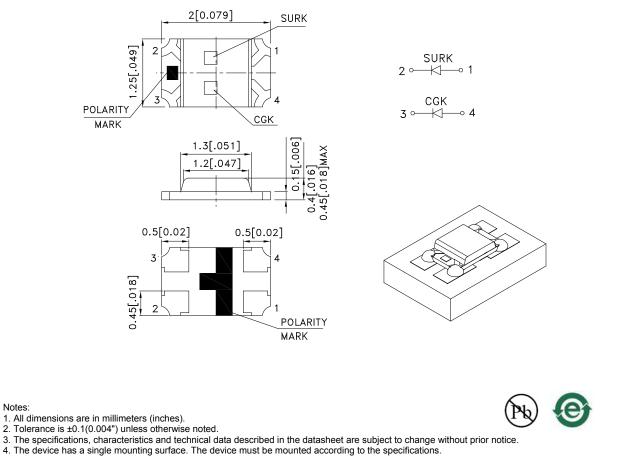
#### Features

- 2.0mmx1.25mm SMT LED, 0.45mm max. thickness.
- Bi -color, low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package : 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

#### Description

The Hyper Red source color devices are made with Al-GalnP on GaAs substrate Light Emitting Diode. The Green source color devices are made with AlGalnP on GaAs substrate Light Emitting Diode.

#### Package Dimensions



REV NO: V.5 CHECKED: Allen Liu DATE: APR/26/2010 DRAWN: SHANW PAGE: 1 OF 6 ERP: 1203005979

Selection Guide	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
KPHBM-2012SURKCGKC	Hyper Red (AlGaInP)		70	220	120°
	Green (AlGaInP)	WATER CLEAR	18	50	

Notes:

1.  $\theta$ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

2. Luminous intensity/ luminous Flux: +/-15%.

### Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red Green	650 574		nm	I⊧=20mA
λD [1]	Dominant Wavelength	Hyper Red Green	630 570		nm	I⊧=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red Green	28 20		nm	I⊧=20mA
С	Capacitance	Hyper Red Green	35 15		pF	VF=0V;f=1MHz
Vf [2]	Forward Voltage	Hyper Red Green	1.95 2.1	2.5 2.5	V	I⊧=20mA
lr	Reverse Current	Hyper Red Green		10 10	uA	VR = 5V

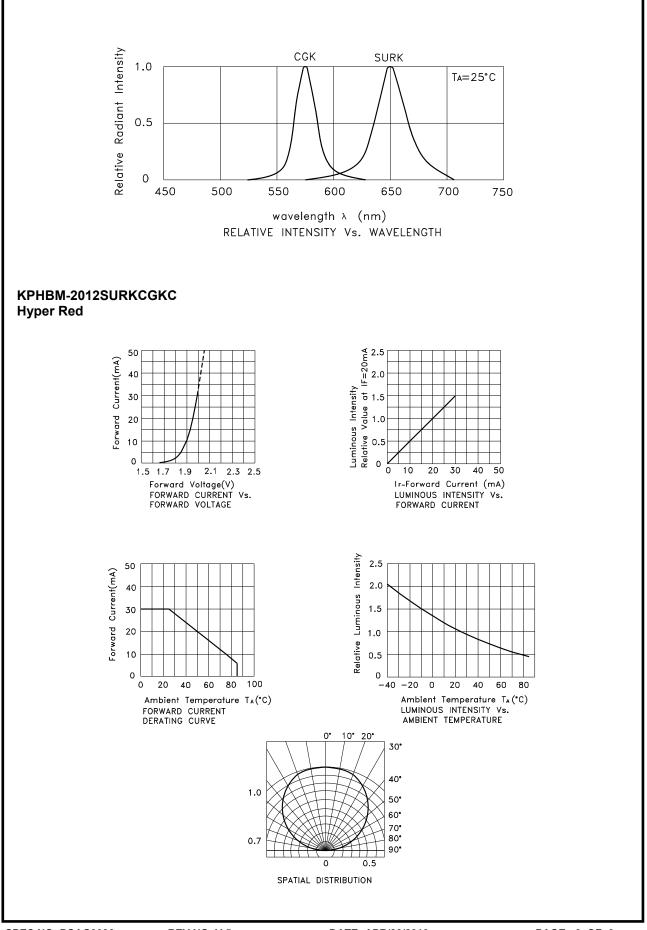
Notes:

1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

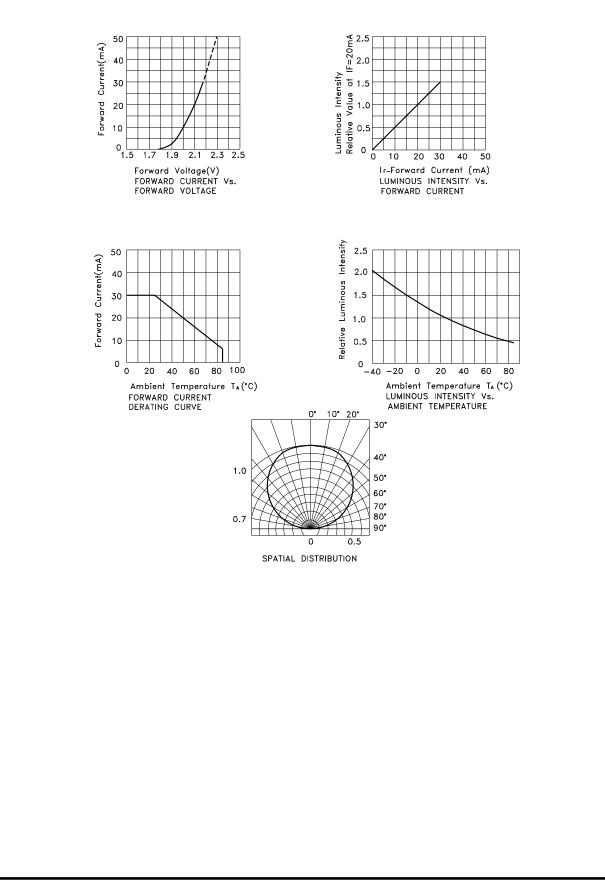
### Absolute Maximum Ratings at TA=25°C

Parameter	Hyper Red	Green	Units		
Power dissipation	75	75	mW		
DC Forward Current	30	30	mA		
Peak Forward Current [1]	185	150	mA		
Reverse Voltage		V			
Operating Temperature	-40°C To +85°C				
Storage Temperature	-40°C To +85°C				

Note: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.



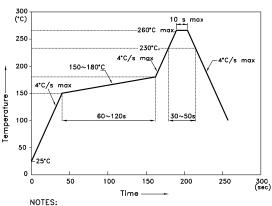




### **KPHBM-2012SURKCGKC**

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

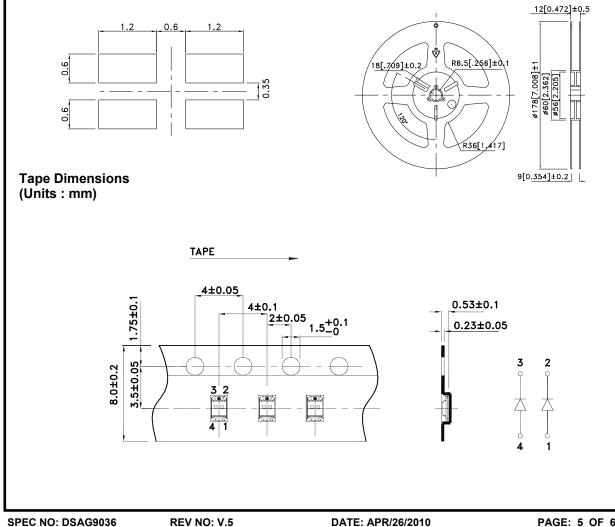
Reflow Soldering Profile For Lead-free SMT Process.



NOTES: 1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C. 2.Don't cause stress to the epoxy resin while it is exposed to high temperature. 3.Number of reflow process shall be 2 times or less.



### **Reel Dimension**



**DRAWN: SHANW** 

